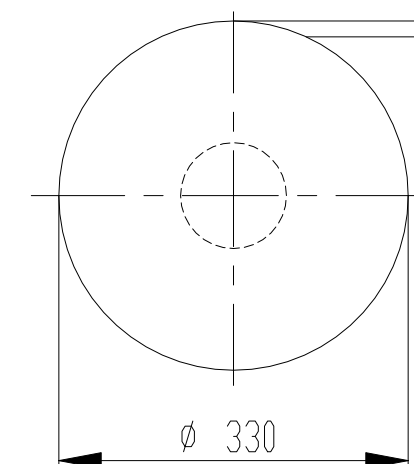
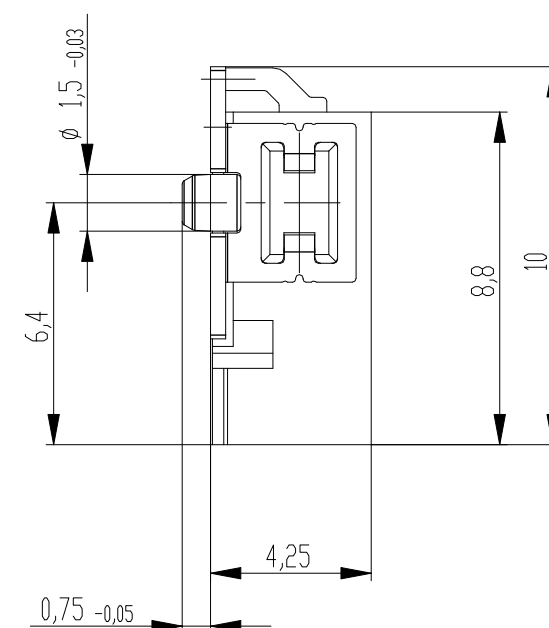
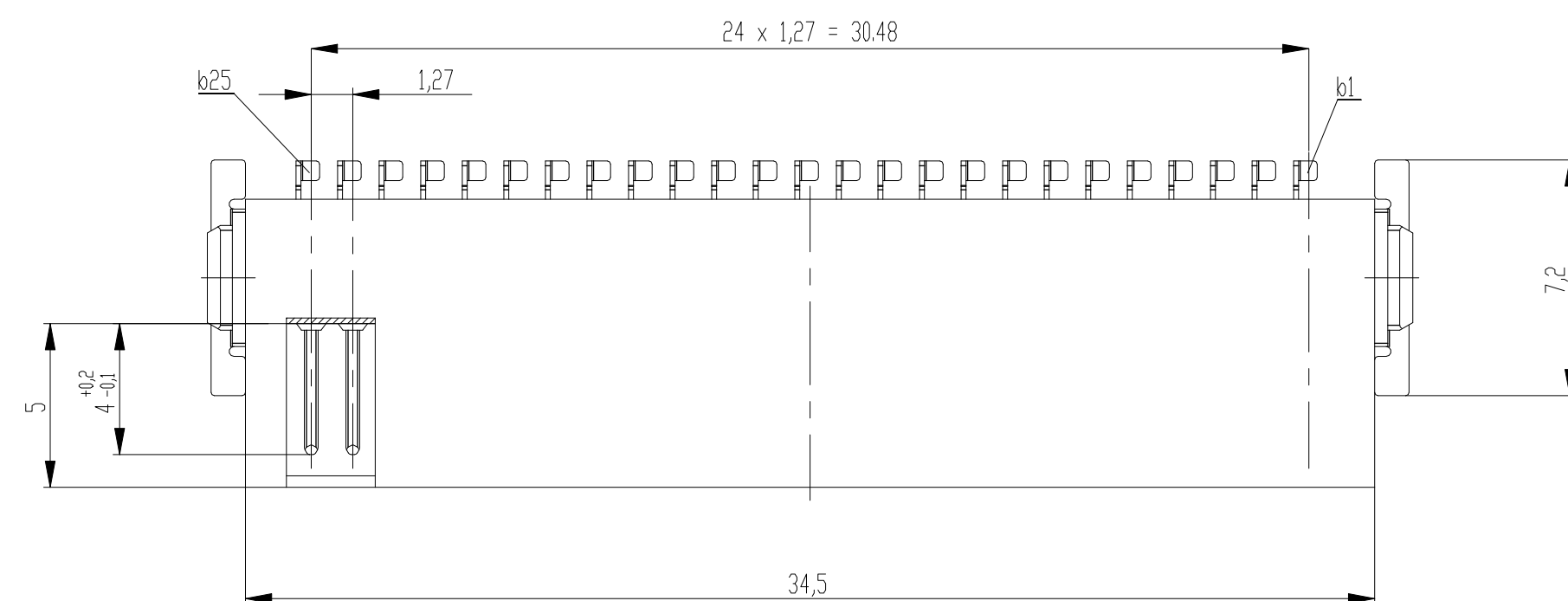
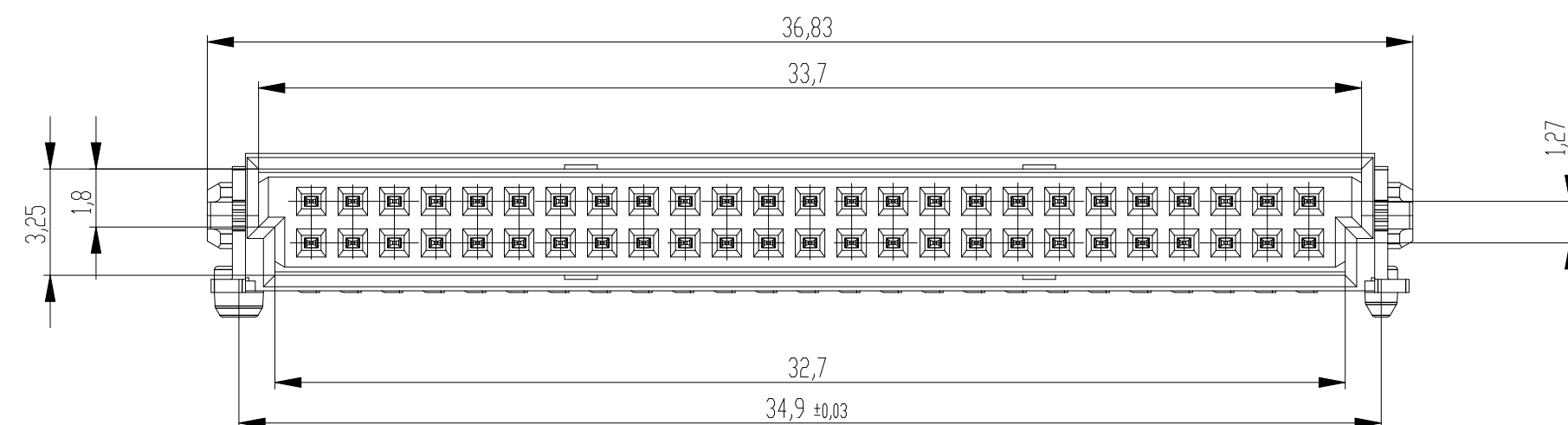
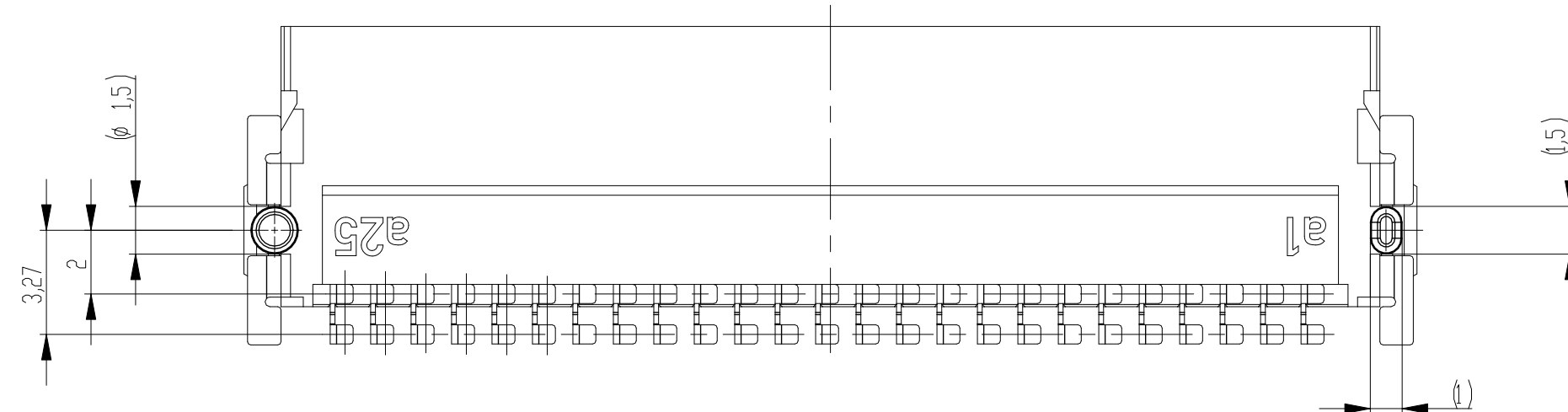
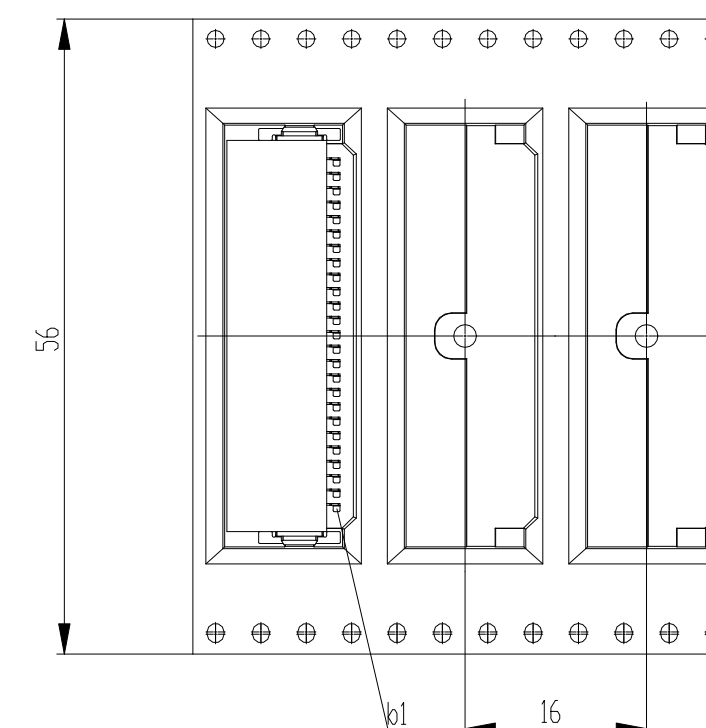
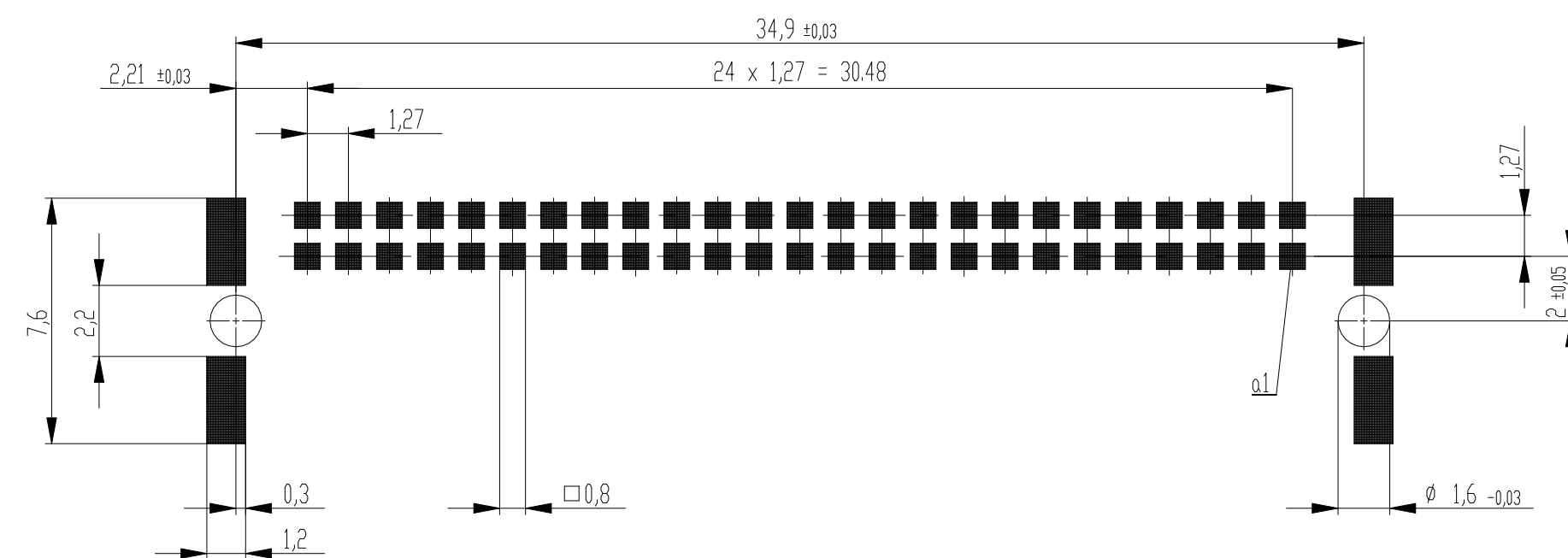




Abspulrichtung - reel off direction



Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT

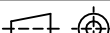


Anforderungsstufe 1
performance level 1

Kontaktbereich vergoldet
mating area gold plating

Anschlussbereich verzinnt 4-6 μ m
terminal area 4-6 μ m tin plating

Koplanarität der Anschlüsse $\leq 0,1 \text{ mm}$
coplanarity area of termination $\leq 0,1 \text{ mm}$

Dimension no.				Tolerances Dim. for Information ISO 8015		 All Dimensions in mm		Scale 5:1													
Customer drawing: THIS DRAWING IS A CONTROLLED DOCUMENT.				Subject to modification without prior notice. Drawing will not be updated.		ERNI-Messersl. SMC-B 50-SMD-BA7-03 Male SMC-B 50-SMD-type7-03															
<table><tr><td>f</td><td></td><td>28.01.2020</td><td></td></tr><tr><td>Index</td><td></td><td>Date</td><td></td></tr></table>				f		28.01.2020		Index		Date		 TE Connectivity		©154765-E						1	
f		28.01.2020																			
Index		Date																			
A2																					
Class						SMCB															